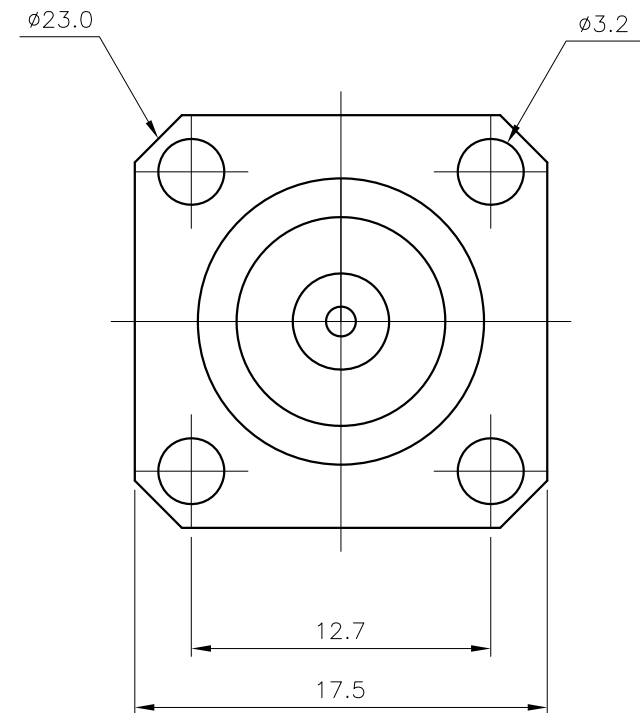
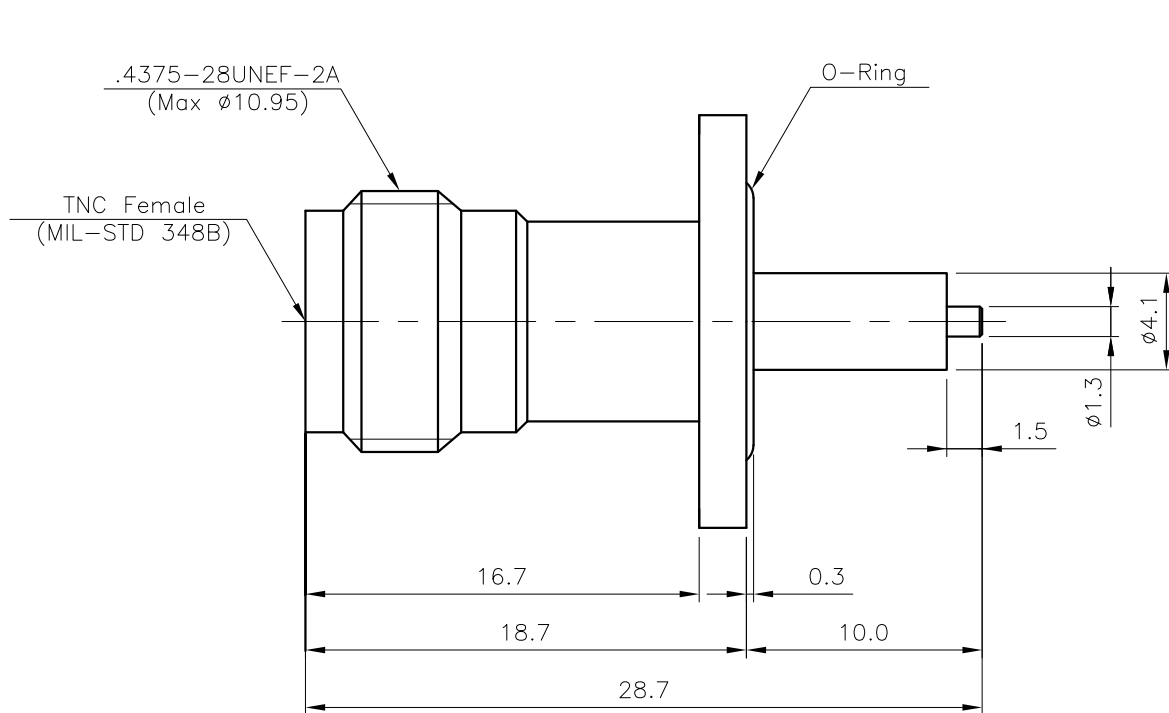


REVISION					
REV	DESCRIPTION	DRAWN	APPR	DATE	
IR	Initial Registration	S.M.LEE	I.C.KIM	2015.08.28.	
1	[설번처리No.201510-0020] BODY 재질 변경 SUS->MBsBD	I.C.KIM		2015.10.23.	
2	[설번No.202211-0009] 조립차수 감안하여 조립공차 변경	S.Y.EUN	S.H.KIM	2022.11.10.	
3	[설번No.202304-0001] 핀 회전 개선 바디 및 핀 널링 추가	S.H.KIM		2023.04.10.	



* 도금은 이원합금(BODY)이며,
염수분무 720시간을 만족함

*ELECTRICAL

Impedance : 50 Ohm
Freq. Range : DC to 6 GHz
VSWR (Max) : 1.22
Working Voltage :500 Vrms @Sea level
Dielectric Withstand Voltage : 1500Vrms
Insulation Resistance :5000 MOhms Min
Contact Resistance (center):2.0 mohm
(outer):3.0 mohm

*MECHANICAL

Interface Dimensions : MIL-STD-348
Force to Engage and Disengage : N/A
Coupling Nut Retention Force and Proof Torque N/A
Connector Durability : 500 mating cycles min.

*ENVIRONMENTAL

Temp. Range : -65°C to +125°C
Thermal Shock : MIL-STD-202, Method 107, Test Cond. B
Vibration : MIL-STD-202, Method 204, Test Cond. D
Shock : MIL-STD-202, Method 213, Test Cond. I

4	Gasket	1	Silicon Rubber		DGK00028-N/1
3	INSULATOR	1	PTFE		DIN02547-N/6 DIN02547-N/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT03413-5/6 DCT03413-5/2
1	BODY	1	MBsBD C3604BD-F SUS303	이원합금(Ni/주석)	DBD03881-5/5 DBD03881-5/3
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	2 Decimal ±0.2±0.1	DATE2023. 04. 10.			KJCOMTECH KJ COMTECH CO.,LTD.		RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY						
MATERIAL		CHECKED BY			TITLE TNC50 SOLDER END JS-4H			
		DRAWN BYS.H.KIM						
FINISH		SCALE 3/1	UNIT mm		A4	DWG NO. CN03385-7/3		SHEET 1 of 1
						REVISION3		